EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet High Power LED – 1W

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EHP-AX08L/SUG01-P01

Features

- Feature of the device: small package with high efficiency
- View angle: 130°.
- High light flux output: more than 50lm@350mA.
- ESD protection.
- Soldering methods: Hot bar soldering
- Grouping parameter: total luminous flux, dominant wavelength.
- Optical efficiency: 37 lm/W.
- Thermal resistance (junction to lead): 15 K/W.
- The product itself will remain within RoHS compliant version.

Applications

- TFT LCD display backlight
- Decorative and entertainment illumination
- Signal and symbol luminaries for orientation marker lights (e.g. steps, exit ways, etc.)
- Exterior and interior automotive illumination

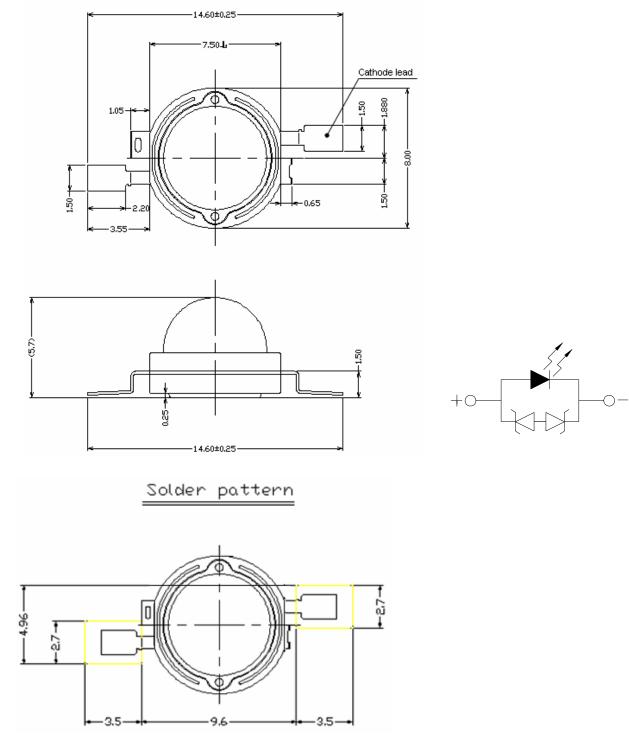


Materials

Items	Description	
Housing black body	Heat resistant polymer	
Encapsulating Resin	Silicone resin	
Lens	Heat resistant clear polymer	
Electrodes	Ag plating copper alloy	
Die attach	Silver paste	
Chip	InGaN	



Dimensions



Notes: 1. Dimensions are in millimeters 2. Tolerances unless dimensions ±0.25mm

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Maximum Ratings (T Ambient=25°C)

Parameter	Symbol	Rating	Unit
Operating Temperature	T _{opr}	-40 ~ +100	℃
Storage Temperature	T _{stg}	-40 ~ +100	°C
Junction temperature	Tj	125	٥C
Forward Current	I _F	500	mA
Power Dissipation	P _d	2.0	W
Junction to heat-sink thermal resistance	R _{th}	15	K/W

Electro-Optical Characteristics (T Ambient=25°C)

Parameter	Bin	Symbol	Min	Тур.	Max	Unit	Condition
Luminous Flux ₍₁₎	J3	${\pmb \phi}_{v}$	33		39	Im	
	J4		39		45		
	J5		45		52		
	K1		52		60		
Viewing Angle ₍₂₎		20 _{1/2}		130		deg	
Wavelength ₍₃₎	C6	λa	515		520	nm	I _F =350mA
	G1		520		525		
	G2		525		530		
	G3		530		535		
	V2	V _F	3.25		3.55	v	
Forward Voltage ₍₄₎	V3		3.55		3.85		
	V4		3.85		4.15		

Note. 1. Luminous flux measurement tolerance : ±10%

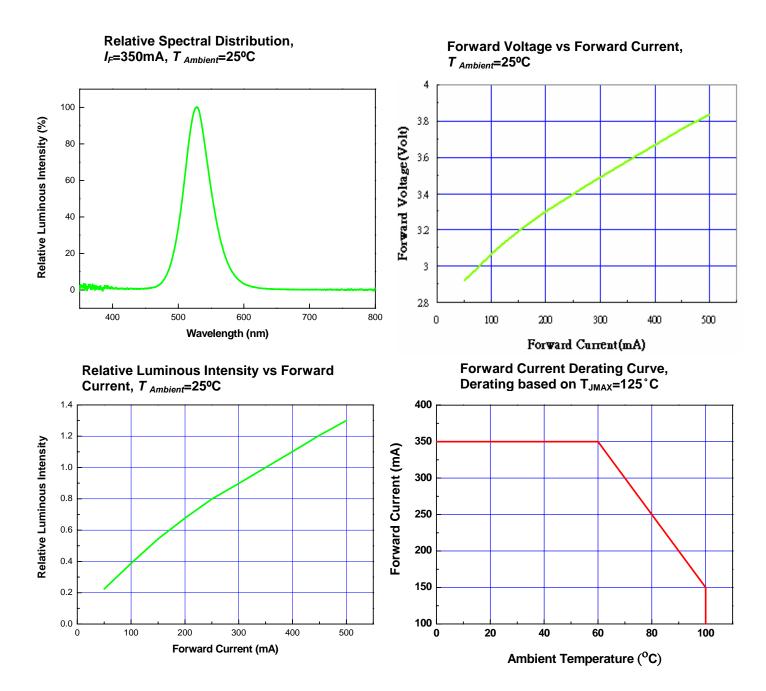
2.2 $\theta_{1/2}$ is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.

- 3. Wavelength measurement tolerance : ±1nm
- 4. Forward Voltage measurement tolerance : ±0.1V

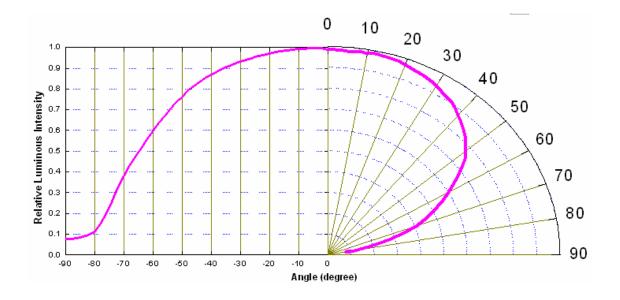
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Typical Electro-Optical Characteristics Curves



Typical Representative Spatial Radiation Pattern



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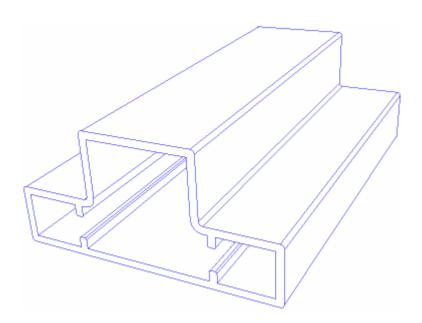
Label explanation

- CPN: Customer's Production Number P/N : Production Number QTY: Packing Quantity CAT: Ranks
- HUE: Peak Wavelength
- **REF: Reference**
- LOT No: Lot Number
- MADE IN TAIWAN: Production Place

EVERLIGHT CPN : RoHS P/N: XXXXXXXXX XX-XXXXXXX QTY: XXXX CAT: Bin lm HUE: Bin \d REF: LOT NO: XXXXXXXX MADE IN TAIWAN

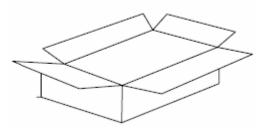
Tube Packing Specifications

1. Tube

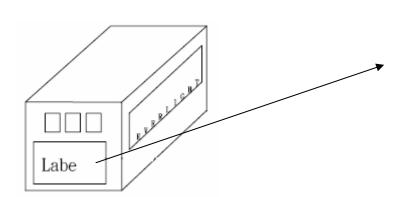




2. Inner Carton



3. Outside Carton





- Packing Quanity
 - 1. 60 Pcs / Per Tube
 - 2. 20 Tubes / Inner Carton
 - 3. 12 Inner Cartons / Outside Carton

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Reliability Test Items and Results

Stress Test	Stress Condition	Stress Duration	
Solderability	Tsol=230°C, 5sec	1 times	
Resistance to Solder Heat	Tsol=260°C, 10sec, 6min	3 times	
Thermal Shock	H: +110°C 20min. ' \int 10sec. 'L: - 40°C 20min.	500 Cycles	
Temperature Cycle	H: +100°C 30min. ' \int 5min. 'L: - 40°C 30min.	1000 Cycles	
High Temperature/Humidity Reverse Bias	Ta=85°C , RH=85%	1000hours	
High Temperature/Humidity Operation	Ta=85℃,RH=60%, IF=225mA	1000hours	
High Temperature Storage	Ta=110°C	1000hours	
Low Temperature Storage	Ta=-40°C	1000hours	
Intermittent operational Life	Ta=25°C, IF=1000mA 30mS on/ 2500mS off	1000hours	
High Temperature Operation Life #1	Ta=55°C, IF=350mA	1000hours	
High Temperature Operation Life #2	Ta=85°C, IF=225mA	1000hours	
High Temperature Operation Life #3	Ta=100°C, IF=150mA	1000hours	
Low Temperature Operation Life	Ta=-40°C, IF=350mA	1000hours	
Power Temperature Cycle	H : +85°C 15min. '∫ 5min. 'L : − 40°C 15min. IF=225mA,2min on/off	1000cycles	
ESD Human Body Model	2000V, Interval:0.5sec	3 times	
ESD Machine Model	200V, Interval:0.5sec	3 times	

*Im: BRIGHTNESS ATTENUATE DIFFERENCE(1000hrs) < 50%

*VF: FORWARD VOLTAGE DIFFERENCE < 20%

Precautions For Use

1. Over-current-proof

Though EHP-A08 has conducted ESD protection mechanism, customer must not use the device in reverse and should apply resistors for extra protection. Otherwise slight voltage shift may cause enormous current change and burn out failure would happen.

2. Storage

- i. Do not open moisture proof bag before the products are ready to use.
- ii. Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
- iii. The LEDs should be used within a year.
- iv. After opening the package, the LEDs should be kept at 30° C or less and 70%RH or less.
- v. The LEDs should be used within 168 hours (7 days) after opening the package.
- vi. If the moisture absorbent material (silicone gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
- vii. Pre-curing treatment : $60\pm5^{\circ}$ C for 24 hours.

3. Thermal Management

 For maintaining the high flux output and achieving reliability, EHP-A08 series LED package should be mounted on a metal core printed circuit board (MCPCB) with proper thermal connection to dissipate approximately 1W of thermal energy under 350mA operation.

MCPCB structure



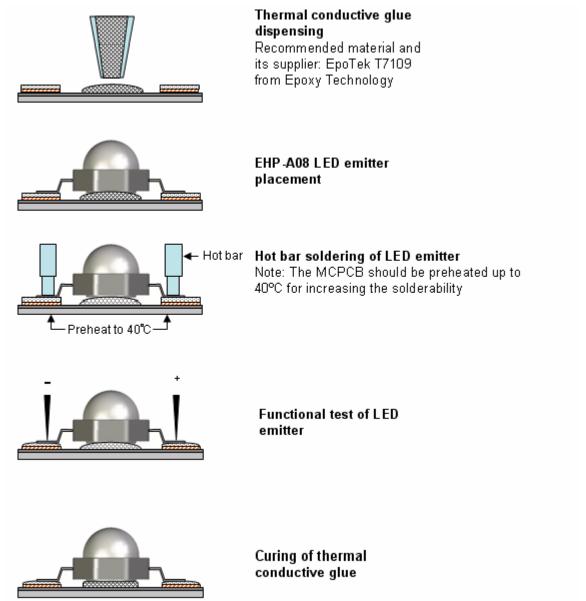
Recommended supplier: • Kavano Industrial Co., Ltd • TT Electronics

- ii. Special thermal designs are also recommended to take in outer heat sink design, such as FR4 PCB on Aluminum with thermal vias or FPC on Aluminum with thermal conductive adhesive, etc.
- iii. Sufficient thermal management must be conducted, or the die junction temperature will be over the limit under large electronic driving and LED lifetime will decrease critically.

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4. Assembly process flow



Handling Indications : Do not handle the EHP-A08 by the lens at any time during the assembly process. This can cause damage to the optical surfaces or may dislocate the lens if excessive force is applied.

5. Soldering Iron

- i. For prototype builds or small series production runs it is possible to place and solder the LED by hand.
- ii. Dispensing thermal conductive glue or grease on the substrates and follow its curing spec. Press LED housing to closely connect LED and substrate.

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- iii. It is recommended to hand solder the leads with a solder tip temperature of 280°C for less than 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal.
- iv. Be careful because the damage of the product is often started at the time of the hand solder.